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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	304
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20se-5f484i

Features

■ High Logic Density for System Integration

- 6K to 95K LUTs
- 90 to 583 I/Os

■ Embedded SERDES (LatticeECP2M Only)

- Data Rates 250 Mbps to 3.125 Gbps
- Up to 16 channels per device
PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.

■ sysDSP™ Block

- 3 to 42 blocks for high performance multiply and accumulate
- Each block supports
 - One 36x36, four 18x18 or eight 9x9 multipliers

■ Flexible Memory Resources

- 55Kbits to 5308Kbits sysMEM™ Embedded Block RAM (EBR)
 - 18Kbit block
 - Single, pseudo dual and true dual port
 - Byte Enable Mode support
- 12K to 202Kbits distributed RAM
 - Single port and pseudo dual port

■ sysCLOCK Analog PLLs and DLLs

- Two GPLLs and up to six SPLLS per device
 - Clock multiply, divide, phase & delay adjust
 - Dynamic PLL adjustment
- Two general purpose DLLs per device

■ Pre-Engineered Source Synchronous I/O

- DDR registers in I/O cells
- Dedicated gearing logic
- Source synchronous standards support
 - SPI4.2, SFI4 (DDR Mode), XGMII
 - High Speed ADC/DAC devices
- Dedicated DDR and DDR2 memory support
 - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
- Dedicated DQS support

■ Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces

- LVTTTL and LVCMOS 33/25/18/15/12
- SSTL 3/2/18 I, II
- HSTL15 I and HSTL18 I, II
- PCI and Differential HSTL, SSTL
- LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL

■ Flexible Device Configuration

- 1149.1 Boundary Scan compliant
- Dedicated bank for configuration I/Os
- SPI boot flash interface
- Dual boot images supported
- TransFR™ I/O for simple field updates
- Soft Error Detect macro embedded

■ Optional Bitstream Encryption (LatticeECP2/M “S” Versions Only)

■ System Level Support

- ispTRACY™ internal logic analyzer capability
- On-chip oscillator for initialization & general use
- 1.2V power supply

Table 1-1. LatticeECP2 (Including “S-Series”) Family Selection

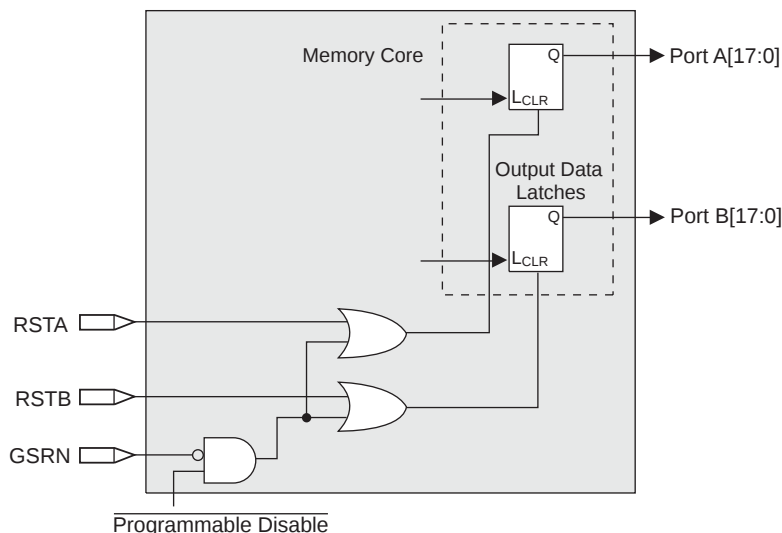
Device	ECP2-6	ECP2-12	ECP2-20	ECP2-35	ECP2-50	ECP2-70
LUTs (K)	6	12	21	32	48	68
Distributed RAM (Kbits)	12	24	42	64	96	136
EBR SRAM (Kbits)	55	221	276	332	387	1032
EBR SRAM Blocks	3	12	15	18	21	60
sysDSP Blocks	3	6	7	8	18	22
18x18 Multipliers	12	24	28	32	72	88
GPLL + SPLL + DLL	2+0+2	2+0+2	2+0+2	2+0+2	2+2+2	2+4+2
Maximum Available I/O	190	297	402	450	500	583
Packages and I/O Combinations						
144-pin TQFP (20 x 20 mm)	90	93				
208-pin PQFP (28 x 28 mm)		131	131			
256-ball fpBGA (17 x 17 mm)	190	193	193			
484-ball fpBGA (23 x 23 mm)		297	331	331	339	
672-ball fpBGA (27 x 27 mm)			402	450	500	500
900-ball fpBGA (31 x 31 mm)						583

2. Write Through – A copy of the input data appears at the output of the same port during a write cycle. This mode is supported for all data widths.

Memory Core Reset

The memory array in the EBR utilizes latches at the A and B output ports. These latches can be reset asynchronously or synchronously. RSTA and RSTB are local signals, which reset the output latches associated with Port A and Port B, respectively. The Global Reset (GSRN) signal resets both ports. The output data latches and associated resets for both ports are as shown in Figure 2-20.

Figure 2-20. Memory Core Reset

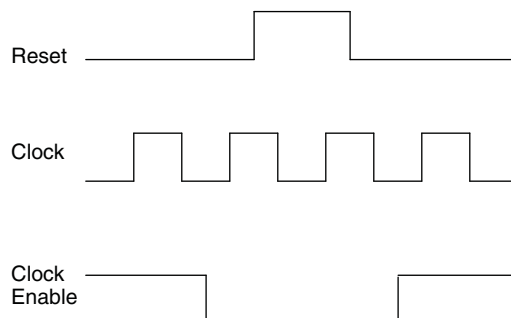


For further information about the sysMEM EBR block, please see the the list of additional technical documentation at the end of this data sheet.

EBR Asynchronous Reset

EBR asynchronous reset or GSR (if used) can only be applied if all clock enables are low for a clock cycle before the reset is applied and released a clock cycle after the reset is released, as shown in Figure 2-21. The GSR input to the EBR is always asynchronous.

Figure 2-21. EBR Asynchronous Reset (Including GSR) Timing Diagram

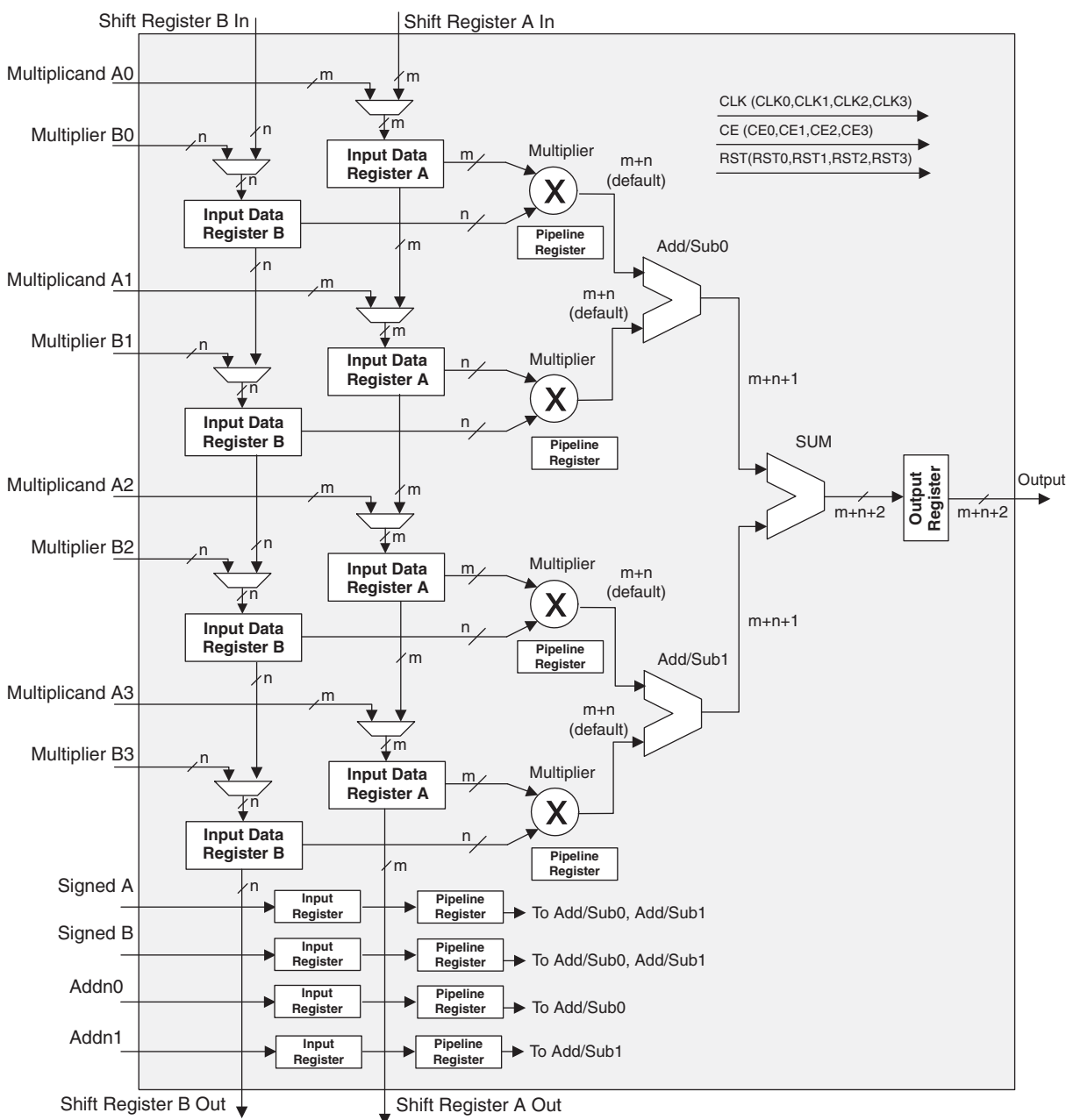


If all clock enables remain enabled, the EBR asynchronous reset or GSR may only be applied and released after the EBR read and write clock inputs are in a steady state condition for a minimum of $1/f_{MAX}$ (EBR clock). The reset release must adhere to the EBR synchronous reset setup time before the next active read or write clock edge.

MULTADDSUBSUM sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and B1. Additionally the operands A2 and B2 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A3 and B3. The result of both addition/subtraction are added in a summation block. The user can enable the input, output and pipeline registers. Figure 2-26 shows the MULTADDSUBSUM sysDSP element.

Figure 2-26. MULTADDSUBSUM



Clock, Clock Enable and Reset Resources

Global Clock, Clock Enable and Reset signals from routing are available to every DSP block. Four Clock, Reset and Clock Enable signals are selected for the sysDSP block. From four clock sources (CLK0, CLK1, CLK2, CLK3)

LatticeECP2M Initialization Supply Current^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ^{5, 6, 7}	Units
I_{CC}	Core Power Supply Current	ECP2M20	41	mA
		ECP2M35	107	mA
		ECP2M50	169	mA
		ECP2M70	254	mA
		ECP2M100	378	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	30	mA
		ECP2M35	30	mA
		ECP2M50	30	mA
		ECP2M70	30	mA
		ECP2M100	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.

2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.

3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.

4. Frequency 0MHz.

5. $T_J = 25^\circ\text{C}$, power supplies at nominal voltage.

6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.

7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

LVDS25E

The top and bottom sides of LatticeECP2/M devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

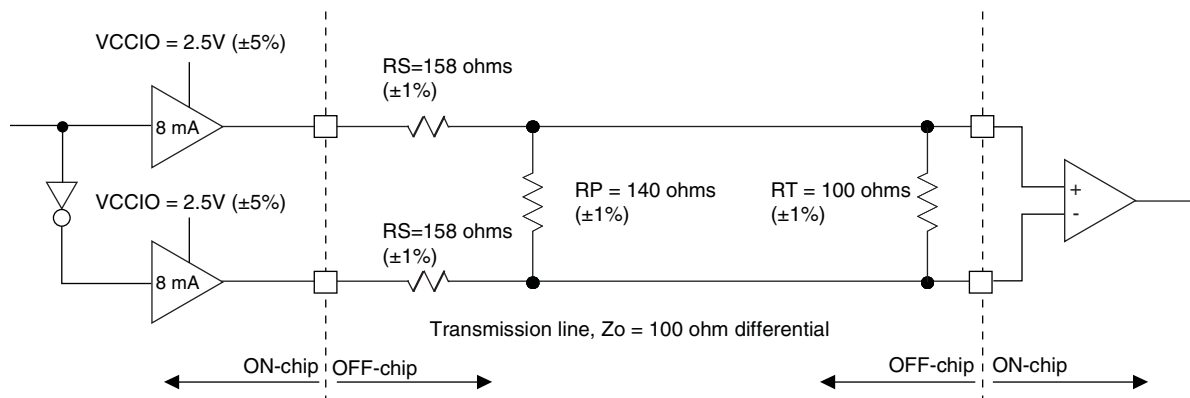


Table 3-2. LVDS25E DC Conditions

Parameter	Description	Typical	Units
V _{CCIO}	Output Driver Supply (+/-5%)	2.50	V
Z _{OUT}	Driver Impedance	20	Ω
R _S	Driver Series Resistor (+/-1%)	158	Ω
R _P	Driver Parallel Resistor (+/-1%)	140	Ω
R _T	Receiver Termination (+/-1%)	100	Ω
V _{OH}	Output High Voltage	1.43	V
V _{OL}	Output Low Voltage	1.07	V
V _{OD}	Output Differential Voltage	0.35	V
V _{CM}	Output Common Mode Voltage	1.25	V
Z _{BACK}	Back Impedance	100.5	Ω
I _{DC}	DC Output Current	6.03	mA

LVCMOS33D

All I/O banks support emulated differential I/O using the LVCMOS33D I/O type. This option, along with the external resistor network, provides the system designer the flexibility to place differential outputs on an I/O bank with 3.3V VCCIO. The default drive current for LVCMOS33D output is 12mA with the option to change the device strength to 4mA, 8mA, 16mA or 20mA. Follow the LVCMOS33 specifications for the DC characteristics of the LVCMOS33D.

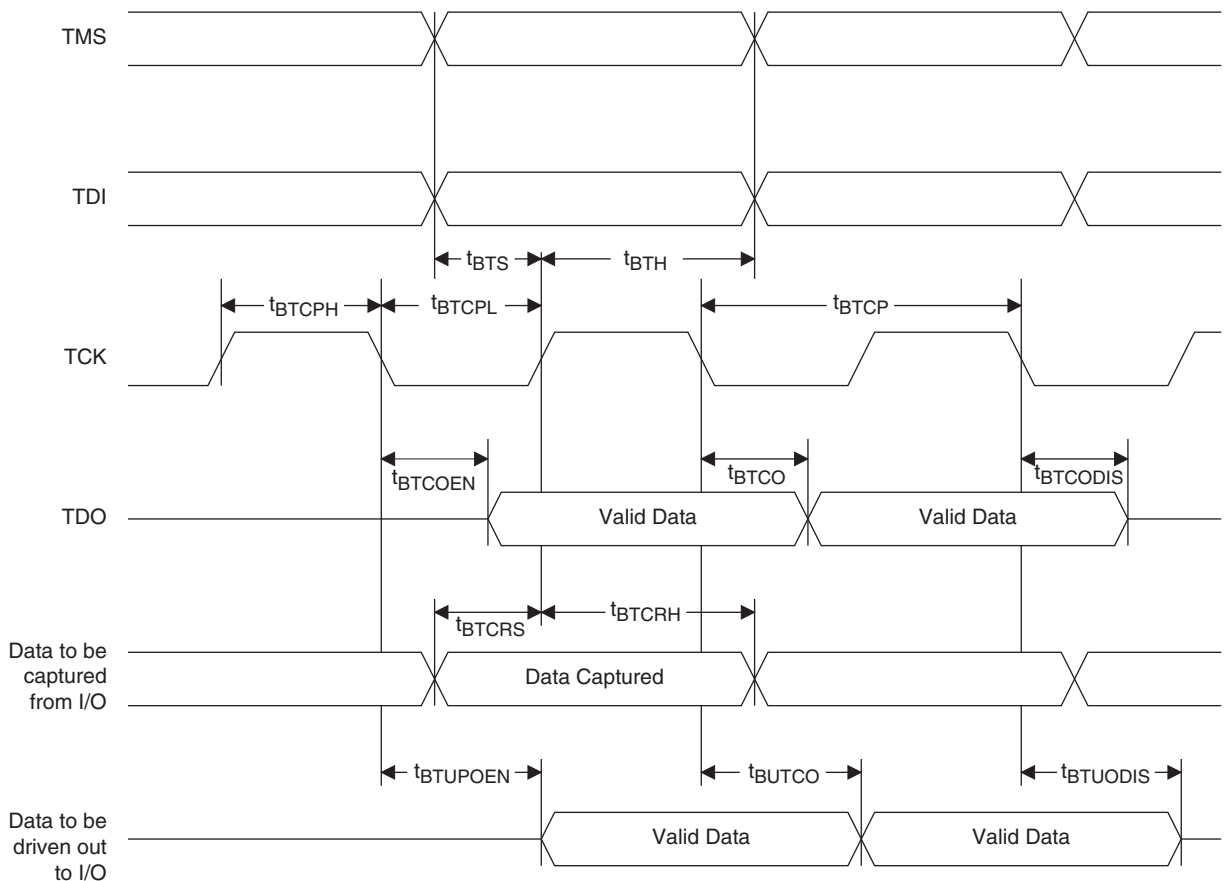
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms





LatticeECP2/M Family Data Sheet

Pinout Information

July 2012

Data Sheet DS1006

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or B (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pins, when not used as special purpose pins, can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration. See “Typical sysI/O I/O Behavior During Power-up” for more information about I/O behavior during power-up.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V _{CC}	—	Power supply pins for core logic. Dedicated pins.
V _{CCAUX}	—	Auxiliary power supply pin. This dedicated pin powers all the differential and referenced input buffers.
V _{CCIOx}	—	Dedicated power supply pins for I/O bank x.
V _{CCPLL}	—	PLL supply pins. Should be tied to V _{CC} even when the corresponding PLL is unused.
V _{REF1_x} , V _{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V _{REF} inputs. When not used, they may be used as I/O pins.
XRES ⁴	—	10K ohm +/-1% resistor must be connected between this pad and ground.
PLLCAP ⁴	—	External capacitor connection for PLL.
PLL, DLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_V _{CCPLL}	—	Power supply pin for PLL: LUM, LLM, RUM, RLM, num = row from center.
[LOC][num]_GPLL[T, C]_IN_A	I	General Purpose PLL (GPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_GPLL[T, C]_FB_A	I	Optional feedback GPLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_IN_A ⁵	I	Secondary PLL (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_SPLL[T, C]_FB_A ⁵	I	Optional feedback (SPLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_IN_A	I	DLL input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_DLL[T, C]_FB_A	I	Optional feedback (DLL) input pads: LUM, LLM, RUM, RLM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.

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Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCI _{Bm}	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCO _{Bm}	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOUTN _m	O	High-speed output, negative channel m
[LOC]_SQ_HDOUTP _m	O	High-speed output, positive channel m
[LOC]_SQ_HDINN _m	I	High-speed input, negative channel m
[LOC]_SQ_HDINP _m	I	High-speed input, positive channel m
[LOC]_SQ_VCCTX _m ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR _{Xm} ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLs that do not have dedicated I/Os.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
91	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	
92	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
94	VCC	-			VCC	-			
95	GND	-			GND	-			
96	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	
97	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C	
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T	
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*	
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*	
102	VCC	-			VCC	-			
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C	
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T	
105	GND	-			GND	-			
106	VCCIO2	2			VCCIO2	2			
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C	
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T	
111	PT26B	1		C	PT54B	1		C	
112	PT26A	1		T	PT54A	1		T	
113	PT24B	1		C	PT52B	1		C	
114	PT24A	1		T	PT52A	1		T	
115	PT22B	1		C	PT50B	1		C	
116	PT22A	1		T	PT50A	1		T	
117	VCCIO1	1			VCCIO1	1			
118	PT20B	1		C	PT48B	1		C	
119	PT20A	1		T	PT48A	1		T	
120	GND	-			GND	-			
121	PT18B	1		C	PT44B	1		C	
122	PT18A	1		T	PT44A	1		T	
123	PT16A	1			PT40B	1		C	
124	NC	1			PT40A	1		T	
125	PT14B	1		C	PT34B	1		C	
126	PT14A	1		T	PT34A	1		T	
127	NC	1			NC	1			
128	VCC	-			VCC	-			
129	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C	
130	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T	
131	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C	
132	XRES	0			XRES	0			
133	GND	-			GND	-			
134	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T	
135	VCC	-			VCC	-			

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GND	GND	GNDIO5	-		
R4	R4	PB33A	5	BDQS33	T
L6	L6	PB34A	5	BDQ33	T
T4	T4	PB33B	5	BDQ33	C
L7	L7	PB34B	5	BDQ33	C
N7	N7	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO	VCCIO5	5		
M8	M8	PB35B	5	PCLKC5_0/BDQ33	C
GND	GND	GNDIO5	-		
P7	P7	PB40A	4	PCLKT4_0/BDQ42	T
R8	R8	PB40B	4	PCLKC4_0/BDQ42	C
VCCIO	VCCIO	VCCIO4	4		
T5	T5	PB41A	4	BDQ42	T
T6	T6	PB41B	4	BDQ42	C
T8	T8	PB42A	4	BDQS42	T
GND	GND	GNDIO4	-		
R7	R7	PB43A	4	BDQ42	T
T9	T9	PB42B	4	BDQ42	C
T7	T7	PB43B	4	BDQ42	C
L8	L8	PB44A	4	BDQ42	T
VCCIO	VCCIO	VCCIO4	4		
P8	P8	PB45A	4	BDQ42	T
L9	L9	PB44B	4	BDQ42	C
N8	N8	PB45B	4	BDQ42	C
R9	R9	PB46A	4	BDQ42	T
GND	GND	GNDIO4	-		
R10	R10	PB46B	4	BDQ42	C
-	VCC	VCCIO	4		
-	GND	GNDIO4	4		
N9	N9	PB56A	4	BDQ60	T
T10	T10	PB57A	4	BDQ60	T
M9	M9	PB56B	4	BDQ60	C
R11	R11	PB57B	4	BDQ60	C
P10	P10	PB58A	4	BDQ60	T
N11	N11	PB59A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
N10	N10	PB58B	4	BDQ60	C
P11	P11	PB59B	4	BDQ60	C
T11	T11	PB60A	4	BDQS60	T
GND	GND	GNDIO4	-		
M11	M11	PB61A	4	BDQ60	T
T12	T12	PB60B	4	BDQ60	C

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T7	PL29B	6	LDQ28	C	PL43B	6	LDQ42	C	
T6	PL26B	6	LDQ28	C (LVDS)*	PL40B	6	LDQ42	C (LVDS)*	
AA2	PL31A	6	LDQ28	T	PL45A	6	LDQ42	T	
VCCIO	VCCIO6	6			VCCIO6	6			
Y1	PL28A	6	LDQS28	T (LVDS)*	PL42A	6	LDQS42	T (LVDS)*	
AA1	PL31B	6	LDQ28	C	PL45B	6	LDQ42	C	
W1	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*	
V3	PL30B	6	LDQ28	C (LVDS)*	PL44B	6	LDQ42	C (LVDS)*	
GNDIO	GNDIO6	-			GNDIO	-			
V4	PL30A	6	LDQ28	T (LVDS)*	PL44A	6	LDQ42	T (LVDS)*	
U5	TDI	-			TDI	-			
U7	TCK	-			TCK	-			
V6	TDO	-			TDO	-			
V5	TMS	-			TMS	-			
T8	VCCJ	-			VCCJ	-			
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T	
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C	
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T	
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C	
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C	
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T	
GNDIO	GNDIO5	-			GNDIO	-			
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C	
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C	
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
GNDIO	GNDIO5	-			GNDIO	-			
-	-	-			VCCIO5	5			
Y6	PB12A	5	BDQ15	T	PB21A	5	BDQ24	T	
W7	PB11A	5	BDQ15	T	PB20A	5	BDQ24	T	
Y7	PB12B	5	BDQ15	C	PB21B	5	BDQ24	C	
W8	PB11B	5	BDQ15	C	PB20B	5	BDQ24	C	
U8	PB14A	5	BDQ15	T	PB23A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
AA7	PB13A	5	BDQ15	T	PB22A	5	BDQ24	T	
U9	PB14B	5	BDQ15	C	PB23B	5	BDQ24	C	

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
R8	VCCIO6	6			VCCIO6	6			
J8	VCCIO7	7			VCCIO7	7			
K7	VCCIO7	7			VCCIO7	7			
L7	VCCIO7	7			VCCIO7	7			
M7	VCCIO7	7			VCCIO7	7			
P15	VCCIO8	8			VCCIO8	8			
R15	VCCIO8	8			VCCIO8	8			
C5	VCCAUX	-			VCCAUX	-			
D11	VCCAUX	-			VCCAUX	-			
E17	VCCAUX	-			VCCAUX	-			
E6	VCCAUX	-			VCCAUX	-			
F13	VCCAUX	-			VCCAUX	-			
G18	VCCAUX	-			VCCAUX	-			
G5	VCCAUX	-			VCCAUX	-			
K5	VCCAUX	-			VCCAUX	-			
M17	VCCAUX	-			VCCAUX	-			
P17	VCCAUX	-			VCCAUX	-			
R5	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V13	VCCAUX	-			VCCAUX	-			
V15	VCCAUX	-			VCCAUX	-			
V7	VCCAUX	-			VCCAUX	-			
V8	VCCAUX	-			VCCAUX	-			
A1	GND	-			GND	-			
A22	GND	-			GND	-			
AA19	GND	-			GND	-			
AA4	GND	-			GND	-			
AB1	GND	-			GND	-			
AB22	GND	-			GND	-			
B19	GND	-			GND	-			
B4	GND	-			GND	-			
C14	GND	-			GND	-			
C9	GND	-			GND	-			
D2	GND	-			GND	-			
D21	GND	-			GND	-			
F17	GND	-			GND	-			
F6	GND	-			GND	-			
H10	GND	-			GND	-			
H11	GND	-			GND	-			
H12	GND	-			GND	-			
H13	GND	-			GND	-			
J14	GND	-			GND	-			
J20	GND	-			GND	-			
J3	GND	-			GND	-			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U1	NC	-			PL34A	6	LDQ31	T
V1	NC	-			PL34B	6	LDQ31	C
GND	GNDIO6	-			GNDIO6	-		
P3	NC	-			NC	-		
R3	NC	-			NC	-		
R4	NC	-			NC	-		
U2	NC	-			NC	-		
VCCIO	VCCIO6	6			VCCIO6	6		
V2	NC	-			NC	-		
W2	NC	-			NC	-		
T6	NC	-			PL38A	6	LDQ39	T
R5	NC	-			PL38B	6	LDQ39	C
GND	GNDIO6	-			GNDIO6	-		
R6	PL25A	6	LDQS25***	T (LVDS)*	PL39A	6	LDQS39***	T (LVDS)*
R7	PL25B	6	LDQ25	C (LVDS)*	PL39B	6	LDQ39	C (LVDS)*
W1	PL26A	6	LDQ25	T	PL40A	6	LDQ39	T
VCCIO	VCCIO6	6			VCCIO6	6		
Y2	PL26B	6	LDQ25	C	PL40B	6	LDQ39	C
Y1	PL27A	6	LLM0_GDLLT_IN_A**/LDQ25	T (LVDS)*	PL41A	6	LLM0_GDLLT_IN_A**/LDQ39	T (LVDS)*
AA2	PL27B	6	LLM0_GDLLC_IN_A**/LDQ25	C (LVDS)*	PL41B	6	LLM0_GDLLC_IN_A**/LDQ39	C (LVDS)*
T5	PL28A	6	LLM0_GDLLT_FB_A/LDQ25	T	PL42A	6	LLM0_GDLLT_FB_A/LDQ39	T
GND	GNDIO6	-			GNDIO6	-		
T7	PL28B	6	LLM0_GDLLC_FB_A/LDQ25	C	PL42B	6	LLM0_GDLLC_FB_A/LDQ39	C
R8	VCC	6			VCCPLL	6		
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
U3	PL30A	6	LLM0_GPLLT_IN_A**/LDQ34	T (LVDS)*	PL44A	6	LLM0_GPLLT_IN_A**/LDQ48	T (LVDS)*
U4	PL30B	6	LLM0_GPLLC_IN_A**/LDQ34	C (LVDS)*	PL44B	6	LLM0_GPLLC_IN_A**/LDQ48	C (LVDS)*
V3	PL31A	6	LLM0_GPLLT_FB_A/LDQ34	T	PL45A	6	LLM0_GPLLT_FB_A/LDQ48	T
U5	PL31B	6	LLM0_GPLLC_FB_A/LDQ34	C	PL45B	6	LLM0_GPLLC_FB_A/LDQ48	C
V4	PL32A	6	LDQ34	T (LVDS)*	PL46A	6	LDQ48	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V5	PL32B	6	LDQ34	C (LVDS)*	PL46B	6	LDQ48	C (LVDS)*
Y3	PL33A	6	LDQ34	T	PL47A	6	LDQ48	T
Y4	PL33B	6	LDQ34	C	PL47B	6	LDQ48	C
W3	PL34A	6	LDQS34	T (LVDS)*	PL48A	6	LDQS48	T (LVDS)*
GND	GNDIO6	-			GNDIO6	-		
W4	PL34B	6	LDQ34	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*
AA1	PL35A	6	LDQ34	T	PL49A	6	LDQ48	T
AB1	PL35B	6	LDQ34	C	PL49B	6	LDQ48	C
VCCIO	VCCIO6	6			VCCIO6	6		
U8	PL36A	6	LDQ34	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*
U7	PL36B	6	LDQ34	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*
V8	PL37A	6	LDQ34	T	PL51A	6	LDQ48	T
U6	PL37B	6	LDQ34	C	PL51B	6	LDQ48	C
GND	GNDIO6	-			GNDIO6	-		
W6	PL38A	6	LDQ42	T (LVDS)*	PL52A	6	LDQ56	T (LVDS)*

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C20	PT75B	1		C	PT93B	1		C
D20	PT75A	1		T	PT93A	1		T
A22	PT74B	1		C	PT92B	1		C
A21	PT74A	1		T	PT92A	1		T
GND	GNDIO1	-			GNDIO1	-		
E19	PT71B	1		C	PT85B	1		C
C19	PT71A	1		T	PT85A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B21	PT70B	1		C	PT79B	1		C
B20	PT70A	1		T	PT79A	1		T
D19	PT69B	1		C	PT78B	1		C
B19	PT69A	1		T	PT78A	1		T
GND	GNDIO1	-			GNDIO1	-		
G17	PT68B	1		C	PT77B	1		C
E18	PT68A	1		T	PT77A	1		T
G19	PT67B	1		C	PT76B	1		C
F17	PT67A	1		T	PT76A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A20	PT66B	1		C	PT75B	1		C
A19	PT66A	1		T	PT75A	1		T
E17	PT65B	1		C	PT74B	1		C
D18	PT65A	1		T	PT74A	1		T
B18	PT64B	1		C	PT73B	1		C
GND	GNDIO1	-			GNDIO1	-		
A18	PT64A	1		T	PT73A	1		T
E16	PT63B	1		C	PT72B	1		C
G16	PT63A	1		T	PT72A	1		T
F16	PT62B	1		C	PT71B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
H18	PT62A	1		T	PT71A	1		T
A17	PT61B	1		C	PT70B	1		C
B17	PT61A	1		T	PT70A	1		T
C18	PT60B	1		C	PT69B	1		C
B16	PT60A	1		T	PT69A	1		T
C17	PT59B	1		C	PT68B	1		C
GND	GNDIO1	-			GNDIO1	-		
D17	PT59A	1		T	PT68A	1		T
E15	PT58B	1		C	PT67B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
G15	PT58A	1		T	PT67A	1		T
A16	PT57B	1		C	PT66B	1		C
B15	PT57A	1		T	PT66A	1		T
D15	PT56B	1		C	PT65B	1		C
F15	PT56A	1		T	PT65A	1		T
A14	PT55B	1		C	PT64B	1		C
B14	PT55A	1		T	PT64A	1		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT54B	1		C	PT63B	1		C
A15	PT54A	1		T	PT63A	1		T
A13	PT53B	1		C	PT62B	1		C
B13	PT53A	1		T	PT62A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT52B	1		C	PT61B	1		C
H15	PT52A	1		T	PT61A	1		T
D13	PT51B	1		C	PT60B	1		C
C14	PT51A	1		T	PT60A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT50B	1		C	PT59B	1		C
E14	PT50A	1		T	PT59A	1		T
A12	PT49B	1		C	PT58B	1		C
B12	PT49A	1		T	PT58A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT48B	1	PCLKC1_0	C	PT57B	1	PCLKC1_0	C
D14	PT48A	1	PCLKT1_0	T	PT57A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T
A11	PT45B	0		C	PT54B	0		C
B11	PT45A	0		T	PT54A	0		T
C13	PT44B	0		C	PT53B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT44A	0		T	PT53A	0		T
D12	PT43B	0		C	PT52B	0		C
F13	PT43A	0		T	PT52A	0		T
A10	PT42B	0		C	PT51B	0		C
B10	PT42A	0		T	PT51A	0		T
C12	PT41B	0		C	PT50B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT41A	0		T	PT50A	0		T
G13	PT40B	0		C	PT49B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT40A	0		T	PT49A	0		T
A9	PT39B	0		C	PT48B	0		C
B9	PT39A	0		T	PT48A	0		T
E12	PT38B	0		C	PT47B	0		C
G12	PT38A	0		T	PT47A	0		T
A8	PT37B	0		C	PT46B	0		C
B8	PT37A	0		T	PT46A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT36B	0		C	PT45B	0		C
C9	PT36A	0		T	PT45A	0		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

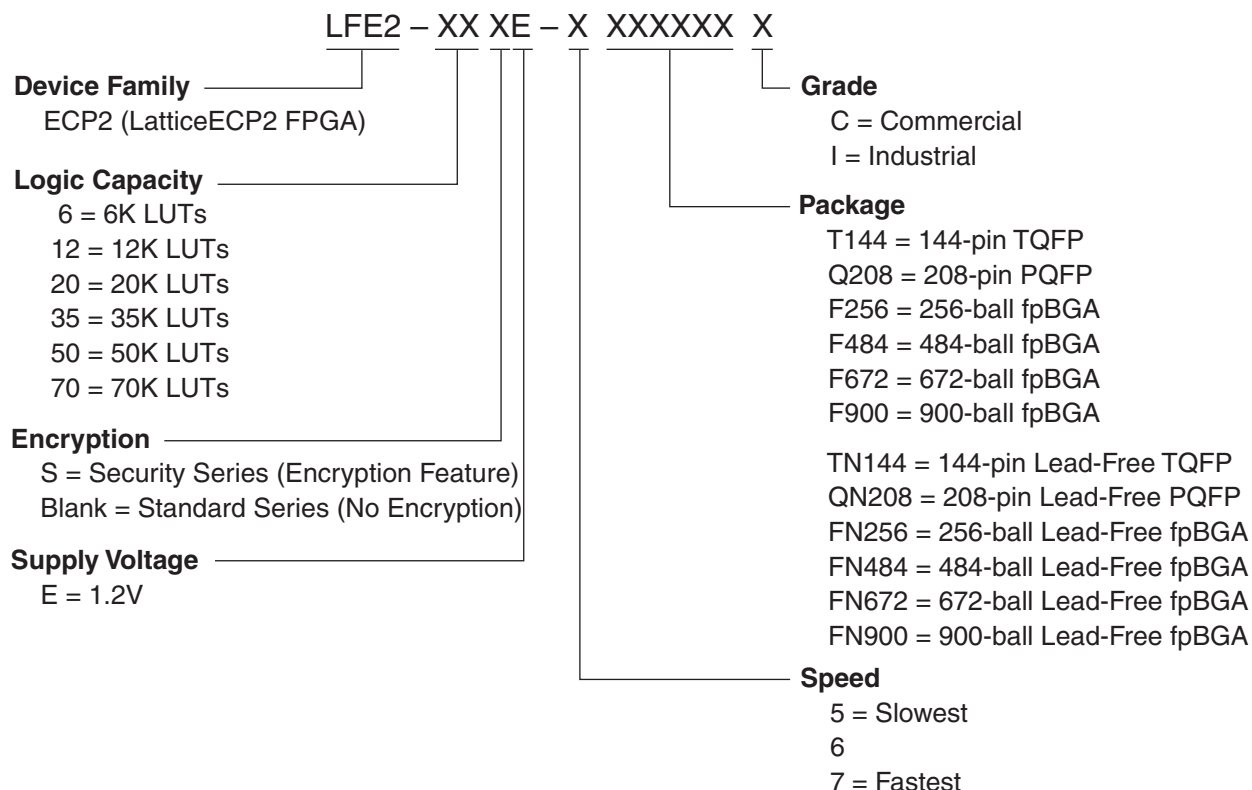
LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D25	PT99A	1		T
J22	PT98B	1		C
J21	PT98A	1		T
VCCIO	VCCIO1	1		
B25	PT97B	1		C
A25	PT97A	1		T
E24	PT96B	1		C
F24	PT96A	1		T
GND	GNDIO1	-		
F23	PT95B	1		C
H22	PT95A	1		T
D24	PT94B	1		C
C24	PT94A	1		T
VCCIO	VCCIO1	1		
E23	PT93B	1		C
G23	PT93A	1		T
B24	PT92B	1		C
A24	PT92A	1		T
C27	PT91B	1		C
GND	GNDIO1	-		
D27	PT91A	1		T
C26	PT90B	1		C
D26	PT90A	1		T
A27	PT89B	1		C
VCCIO	VCCIO1	1		
B27	PT89A	1		T
A28	PT88B	1		C
B28	PT88A	1		T
A29	PT87B	1		C
B29	PT87A	1		T
GND	GNDIO1	-		
VCCIO	VCCIO1	1		
H21	PT80B	1		C
F22	PT80A	1		T
VCCIO	VCCIO1	1		
B23	PT79B	1		C
A23	PT79A	1		T
G24	PT78B	1		C
E22	PT78A	1		T
GND	GNDIO1	-		
D22	PT77B	1		C
C22	PT77A	1		T
G22	PT76B	1		C

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

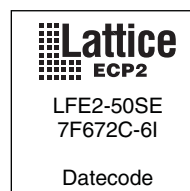
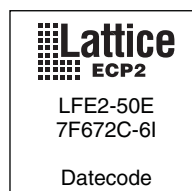
LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
J16	PT51B	1		C	PT60B	1		C	
G15	PT51A	1		T	PT60A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
C16	PT50B	1		C	PT59B	1		C	
D16	PT50A	1		T	PT59A	1		T	
J15	PT49B	1		C	PT58B	1		C	
H15	PT49A	1		T	PT58A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
A15	PT48B	1	VREF2_1	C	PT57B	1	VREF2_1	C	
B15	PT48A	1	VREF1_1	T	PT57A	1	VREF1_1	T	
F15	PT47B	1	PCLKC1_0	C	PT56B	1	PCLKC1_0	C	
E16	PT47A	1	PCLKT1_0	T	PT56A	1	PCLKT1_0	T	
C15	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
D15	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T	
C14	PT45B	0	VREF2_0	C	PT54B	0	VREF2_0	C	
E15	PT45A	0	VREF1_0	T	PT54A	0	VREF1_0	T	
G14	PT44B	0		C	PT53B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
J14	PT44A	0		T	PT53A	0		T	
F14	PT43B	0		C	PT52B	0		C	
H14	PT43A	0		T	PT52A	0		T	
A14	PT42B	0		C	PT51B	0		C	
B14	PT42A	0		T	PT51A	0		T	
D13	PT41B	0		C	PT50B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
F13	PT41A	0		T	PT50A	0		T	
G13	PT40B	0		C	PT49B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
J11	PT40A	0		T	PT49A	0		T	
D4	PT38B	0		C	PT47B	0		C	
D5	PT38A	0		T	PT47A	0		T	
E5	PT37B	0		C	PT46B	0		C	
F6	PT37A	0		T	PT46A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
F7	PT34B	0		C	PT43B	0		C	
D8	PT34A	0		T	PT43A	0		T	
GNDIO	GNDIO0	-			GNDIO0	-			
J13	PT32B	0		C	PT41B	0		C	
G11	PT32A	0		T	PT41A	0		T	
H13	PT31B	0		C	PT40B	0		C	
H12	PT31A	0		T	PT40A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
E8	PT30B	0		C	PT39B	0		C	
D9	PT30A	0		T	PT39A	0		T	
D12	PT28B	0		C	PT37B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



Date	Version	Section	Change Summary
November 2009 (cont.)	03.5 (cont.)	Pinout Information (cont.)	LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 table - corrected values for LFE2M50, 672 fpBGA in Available DDR-Interfaces per I/O Bank.
			Minor corrections in LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA table.
			Minor corrections in LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA table.
			Minor corrections in LFE2M100E/SE Logic Signal Connections: 900 fpBGA table.
			Updated LFE2-6E/SE and LFE2-12E/SE Logical Signal Connections (changed D1/SPIDS to D1).
		Ordering Information	Updated LatticeECP2M Part Number Description diagram.
March 2010	03.6	DC and Switching Characteristics	Footnote for SED operating frequency added to the sysCONFIG Port Timing Specifications table.
		Pinout Information	Changed Dual Function pin E7 to be D7/SPDI0 in Logic Signal Connections tables. Changed footnote (***) in Logic Signal Connections table.
July 2010	03.7	Architecture	Updated the Typical sysIO Behavior During Power-up text section.
		Pinout Information	Added reference to powerup information.
			Corrected reference to footnote for pins 131 and 132 for the LFE-20E/SE, 208 PQFP.
			Referenced footnote (***) for all D7/SPID0.
			Changed D7*** to D7/SPID0.
			Corrected *** footnote.
		All Sections	Included references to Lattice Diamond design software wherever ispLEVER and ispLeverCORE is specified.
April 2011	03.8	DC and Switching Characteristics	DC Electrical Characteristics table: - Added footnote 3 to I_{IH} - Added footnote 2 to I_{IL} , I_{IH} - Updated C1 and C2 typ. and max. data.
			DLL Timing table – Removed line for t_R and t_F
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added footnote to t_{DINIT} .
			Figure 3-18 – Corrected label to be PRGM (not PRGMRJ).
		Pinout Information	LFE2-12E/SE and LFE-20/SE Logical Signal Connections for 208 PQFP – Corrected Dual Function information for pins 112, 114, 117, 119.
January 2012	03.9	Multiple	Removed references to ispLEVER design software.
		Architecture	Corrected information regarding SED support.
		DC and Switching Characteristics	Added reference to ESD information.
June 2013	04.0	All	Updated document with new corporate logo.
		Architecture	Architecture Overview – Added information on the state of the register on power up and after configuration.